Achieving lowest-power capacitive sensing with PSoC™ 4000T

About this document

Scope and purpose

This application note describes how to use the PSoC™ 4000T device to achieve a capacitive sensing application with the lowest power consumption and provides guidelines for firmware and device configuration and hardware design. This application note focuses on CAPSENSE™ specific guidelines; for PSoC™ 4 general guidelines, see AN86233 - PSoC™ 4 MCU low-power modes and power reduction techniques.

Intended audience

Firmware engineers who configure/use the device for low-power touch-sensing applications.

This document assumes that you are familiar with PSoC™, CAPSENSE™, and ModusToolbox™; see the relevant resources to get started.

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<th>See this</th>
</tr>
</thead>
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<td>AN79953 – Getting started with PSoC™ 4 MCU</td>
</tr>
<tr>
<td>CAPSENSE™ technology</td>
<td>AN85951 – PSoC™ 4 and PSoC™ 6 CAPSENSE™ design guide</td>
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Introduction

1 Introduction

Wearable technology devices from fitness trackers to smart glasses and smart clothes are becoming increasingly popular. Capacitive sensing is one of the key human-machine interface (HMI) used in any wearable solution. Battery life is the major challenge in any wearable technology today; therefore, there is a constant need to lower the power consumption while still having the need for the devices to be responsive all the time.

PSoC™ 4000T addresses this challenge by introducing the new 5th-generation CAPSENSE™ technology, offering an ultra-low-power touch HMI solution. It enables scanning low-power buttons while the device is in deep sleep and processing the results to wake the device in the event of a touch. This technology also has an inherent autonomous scanning capability, which does not need CPU intervention for scanning sensors. The device can be kept in deep sleep while scanning, therefore, reducing the power in active mode as well.

This application note explains how to design a low-power CAPSENSE™ application with PSoC™ 4000T device and discusses various factors affecting power consumption. It also covers the hardware, firmware, and system recommendations to achieve the lowest power consumption.
Achieving lowest-power capacitive sensing with PSoC™ 4000T

Power consumption in low-power designs

2 Power consumption in low-power designs

Wearable applications must have a long battery life (recharge cycle time). Currently, available fitness trackers and smart watches claim 5-15 days of battery life for normal usage. Battery life is calculated considering the active usage to be approximately 4% (~1 hour per day), which contributes to ~25% of total current consumption, and the remaining 96% time in a low-power mode taking ~75% of remaining current consumption. Therefore, the current usage in low-power mode has a major impact on having an extended battery life.

Most smart wearables use touch sensing as the trigger to transition from a low-power mode to an active mode. Touch-sensing solutions currently have different low-power modes to enable scanning in low-power state and active state.

In low-power mode, MCUs typically scan sensors with a low refresh rate to detect any user activity to transition to active mode with a higher refresh rate to meet the user experience requirement. Low-power mode is achieved by waking the CPU at a low frequency to scan and process the results. This increases the average low-power mode current and impacts the battery life. Figure 1 shows the instantaneous and average current waveform for a sensing MCU in different modes.

Figure 1 Current waveform in low-power mode

PSoC™ 4000T introduces CAPSENSE™ multi-sense low-power (MSCLP) technology, an innovative way to decrease the current in low-power mode scanning by 5-10x (Figure 2) and improving the battery life of applications considerably. This technology has the wake-on-touch (WoT) mode that enables low-power touch detection without requiring the device to be active, i.e., to detect a touch while the device is in deep sleep. MSCLP is also capable of scanning a number of sensors (up to 36 sensors for a PSoC™ 4000T device) autonomously without any CPU intervention and does not need the device main clock for scanning; this reduces the current consumption in active mode as well.
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Power consumption in low-power designs

2.1 Power budgeting

Power budgeting is one of the main factors while designing low-power sensing solutions and is estimated using the required battery life and maximum possible battery capacity. Battery life means how long the end product is required to operate without replacing batteries or recharging them; the maximum possible battery capacity is limited by form factor, size, and cost of the end product.

Battery life can be calculated using the average current for a typical use case using the following equation:

\[
\text{Battery Life} = \frac{\text{Maximum Battery capacity}}{\text{Average current consumption}}
\]

**Equation 1 Battery life**

The average current (power budget) for a battery-powered embedded system can be calculated using the following equation:

\[
\text{Average current} = \frac{(T_{\text{active}} * I_{\text{active}}) + (T_{\text{low-power}} * I_{\text{low-power}})}{(T_{\text{active}} + T_{\text{low-power}})}
\]

**Equation 2 Average current consumption**

Where,
- \(T_{\text{active}}\) – Total time in active power mode
- \(I_{\text{active}}\) – Average current in active power mode
- \(T_{\text{low-power}}\) – Total time in low-power mode
- \(I_{\text{low-power}}\) – Average current in low-power mode
- \(I_{\text{low-power}}\) depends on deep sleep current \(I_{\text{deepsleep}}\), low-power mode refresh rate, scan and processing current, and time. Consider an example when the device is in low-power mode state with the following parameters:

- Low-power mode refresh rate = 16 Hz
- Low-power mode period = 1/16 = 62.5 ms
- Average scan current = 1 mA
- Initialization and scan time = 120 μs
- Deep sleep current = 1.65 μA
- Deep sleep time = 62.5 ms – 0.12 ms = 62.38 ms

Then, low-power average current consumption can be calculated using the following equation:
Achieving lowest-power capacitive sensing with PSoC™ 4000T

Power consumption in low-power designs

\[
I_{\text{low-power}} = \frac{(62.38 \text{ ms} \times 1.65 \mu\text{A}) + (120 \mu\text{s} \times 1 \text{ mA})}{(62.5 \text{ ms})} = 3.57 \mu\text{A}
\]

Equation 3  Low-power average current consumption

2.2  PSoC™ 4000T is best for low-power solutions

PSoC™ 4000T provides 5-10x power consumption reduction in low-power mode and 3-5x power consumption reduction in active mode scanning; having the least power requirement in low-power mode is one of the major criteria for a wearable solution.

Here, comparing the power consumption of PSoC™ 4000T device with the previous CAPSENSE™ generation device (Fourth-generation CAPSENSE™), Table 1 shows the exact improvement in different stages of application power modes.

Table 1  Power consumption comparison

<table>
<thead>
<tr>
<th>Power</th>
<th>Fourth-generation CAPSENSE™</th>
<th>PSoC™ 4000T (Fifth-generation CAPSENSE™ with LP)</th>
<th>Condition</th>
</tr>
</thead>
<tbody>
<tr>
<td>Wake-on-Touch (Lowest power)</td>
<td>36 μA</td>
<td>3.9 μA¹</td>
<td>10 buttons ganged to a total of 40 pF with shield enabled. Shield Cp = 39 pF Refresh rate = 16-Hz. Sensitivity = 0.9 pF.</td>
</tr>
<tr>
<td>Active – Low refresh rate</td>
<td>225 μA</td>
<td>55 μA</td>
<td>13 buttons, each with electrode Cp = 4 pF with shield enabled. Shield Cp=39 pF. Refresh rate = 32-Hz. Sensitivity = 0.4 pF.</td>
</tr>
<tr>
<td>(Intermediate power)</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Active – High refresh rate</td>
<td>750 μA</td>
<td>206 μA</td>
<td>13 buttons, each with electrode Cp = 4 pF with shield enabled. Shield Cp=39 pF. Refresh rate = 128 Hz. Sensitivity = 0.4 pF.</td>
</tr>
<tr>
<td>(Active power)</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

2.3  Factors affecting low-power

When designing a low-power application, you may need to consider some trade-offs such as scan duration, signal-to-noise ratio (SNR), refresh rate, and number of sensors to be scanned while in deep sleep. As shown in Figure 2, while in low-power mode, the scanning stage is the major contributor for power consumption. The scan duration and refresh rate directly impact the power consumption.

2.3.1  Scan duration

Scan duration depends on the parasitic capacitance (Cp) of the sensor because the maximum scan frequency is limited by Cp. A lower sensor Cp reduces the scan duration, which in turn lowers the power consumption. See Hardware design considerations to understand techniques to be used to reduce the sensor Cp.

¹ Measured with the kit having Deep Sleep current of 1.7 μA. Expected ~4.7 μA if the kit has typical Deep Sleep current of 2.5 μA.
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Power consumption in low-power designs

2.3.2 Refresh rate

Refresh rate should be decided based on the user experience and power consumption (see Section 3.2.3). Having a lower refresh rate reduces the power requirement but it will negatively impact the response performance. In most use cases, low-power sensors are used for waking up the device; a lower refresh rate means that the user needs to press the button a little longer to wake up the application.

2.3.3 Signal-to-noise ratio (SNR)

Another contributing factor for scan duration is the signal-to-noise ratio (SNR); noise can be reduced using built-in IIR filters (see Section 3.3.3), therefore, increasing the SNR to the requirement without increasing the scan time.

2.3.4 Number of sensors in low-power mode

As mentioned in section 2.3.1, having a low-Cp sensor in low-power mode reduces the power consumption; therefore, to have a dedicated wakeup button would be ideal. If there are multiple sensors that need to be scanned for a specific application (such as a touchpad), ganging them all together will help in reducing the power consumption.

For example, scanning five sensors together (ganged sensor) requires less power than scanning them separately even though the combined Cp scanned in low-power mode is the same. This is because separate scanning requires separate initialization.

2.4 Power estimation

To get a better estimation and identify areas to improve power consumption, it is important to know the power consumption at each stage of scanning such as – initialization, scanning, and processing.

2.4.1 Current consumption at different scanning stages

For each user power mode (see Section 3.1.1), based on the scanning stage, the current consumption varies:
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Power consumption in low-power designs

- **Active power mode**: Scanning stages consist of CAPSENSE™ hardware and firmware initialization, scanning, processing, and deep sleep (Active Mode in Figure 2). Note that the PSoC™ 4 device is in deep sleep mode in all the stages except processing.

- **Low-power mode**: Scanning stages consist of CAPSENSE™ hardware initialization, scanning, and deep sleep (Low-power mode in Figure 2)

Even if the scan duration is the same in active and deep sleep modes, current consumption varies because of the low refresh rate and reduction in scanning stages.

Figure 2   Active mode scanning stages
Firmware design considerations

3 Firmware design considerations

3.1 Power modes available in PSoC™ 4000T

Low-power modes are categorized as follows:

- Application (user) power states
- CAPSENSE™ (MSCLP) hardware-level power modes

3.1.1 Power consumptions in different application states

Application power modes define different states to scan the sensors based on user activity. You can define any number of states according to the application requirement to reduce the overall power consumption. Each state consumes only the minimum required power that is specific to that application; three modes are considered to cover most of the use cases for PSoC™ 4000T solutions:

- **Active**: To have highest refresh rate while the user is actively using the solution.
- **Active low refresh rate (ALR)**: To have scanning at a low refresh rate on all sensors, this is an optional power mode and can also have multiple ALR mode based on application requirement. This acts as an intermediate state while transferring from the active to Wake-on-Touch state based on reduced user activity. This mode can also be used for periodically updating baselines of the sensor when there is no user activity for a long time.
- **Wake-on-Touch (WoT)**: The lowest-power mode, which scans a reduced number of sensors at a low refresh rate and processes the results without CPU intervention. The reduced list of sensors can be a button such as ‘wakeup/power-up’, proximity sensors, ganged sensors, etc. PSoC™ 4000T can be kept at deep sleep (both CPU and HFCLK is OFF) in this mode while MSCLP is scanning. A low-power interrupt is generated by the MSCLP hardware when there is a user-activity or a timeout detected.

Figure 3 shows the different power modes and transition conditions for a typical use case. The section Firmware techniques for low-power design provides details on implementing different application power modes using CAPSENSE™ middleware and section Low-power CAPSENSE™ example provides a low-power code example and the firmware flowchart showing different user power modes and mode transition based on user activity.
Firmware design considerations

### 3.1.2 CAPSENSE™ hardware scanning modes

The MSCLP CAPSENSE™ hardware supports two hardware scanning modes:

- **CPU (legacy)**
- **Low-power, always-on sensing (LP-AoS).**

**CPU (legacy) mode:** CPU is the only mode supported in the earlier generation CAPSENSE™ (4\(^{th}\) and earlier), where each sensor needs to be configured by the CPU before each sensor scan. In this mode, after initiating the scan for the first sensor, at the end of each sensor scan completion, the CPU is interrupted to read the results, and to configure and initiate the next sensor scan. This mode is not used in PSoC™ 4000T for typical scans and only used for CAPSENSE™ initialization, auto-calibration, and BIST by CAPSENSE™ middleware.

**Low-power always-on sensing (LP-AoS):** Multiple sensors (a frame) can be scanned without the intervention of the CPU. In PSoC™ 4000T, a 1-KB SRAM is available inside the MSCLP hardware; the middleware writes the configuration of multiple sensors to be scanned to the internal SRAM. Then, the MSCLP autonomously reads each sensor configuration, initiates scanning, and saves the result to the SRAM for the middleware to read and process after full-frame scanning is completed.
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Firmware design considerations

Additionally, this mode has the capability of scanning the same frame periodically and processing the result to detect touch. Therefore, the CPU is not required to process or initiate scanning; this allows the PSoC™ device to be kept in Deep Sleep for a longer time and to have the sensor touch detection as a wakeup interrupt. Therefore, the application can get the lowest power consumption with touch-sensing capability.

The device can be kept in any device power mode such as Active, Sleep, or Deep Sleep while MSCLP is scanning multiple sensors. MSCLP has all the system resources such as high-frequency clock and reference generator internal to the MSCLP hardware to enable scanning in device low-power state (i.e., Deep Sleep).

Table 2 shows the user power modes for a typical use case.

<table>
<thead>
<tr>
<th>#</th>
<th>Application power modes</th>
<th>Scope</th>
<th>Refresh rate</th>
<th>Power consumption</th>
<th>Optimum device power mode</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Active (max refresh rate)</td>
<td>All sensors</td>
<td>High</td>
<td>High</td>
<td>• <strong>Active mode</strong>: To trigger scan and process&lt;br&gt;• <strong>Deep sleep mode</strong>(^1): For frame scan and waiting (to achieve required refresh rate).</td>
</tr>
<tr>
<td>2</td>
<td>Active - low refresh rate (ALR)</td>
<td>All sensors</td>
<td>Low</td>
<td>Medium</td>
<td>• <strong>Active mode</strong>: To trigger scan and process&lt;br&gt;• <strong>Deep Sleep mode</strong>: For frame scan and waiting (to achieve required refresh rate).</td>
</tr>
<tr>
<td>3</td>
<td>Wake on touch (WoT)</td>
<td>A few sensors or ganged sensors</td>
<td>Very low</td>
<td>Low</td>
<td>• <strong>Deep Sleep mode</strong>: To scan, process, and wait.</td>
</tr>
</tbody>
</table>

CPU mode is not required for sensor scanning; it is used for CAPSENSE™ initialization, auto-calibration, and BIST by CAPSENSE™ middleware. To get the least power consumption on all application power modes, LP-AoS is best suited and is the default. However, LP-AoS mode always power cycles (switches ON and OFF) the MSCLP system resource between each frame scan; this can reduce the maximum refresh rate.

3.2 Firmware techniques for low-power design

The main objective of firmware techniques is to stay in a low-power mode as long as possible by reducing the scan time and refresh rate, while still ensuring a reliable operation and the best user experience.

3.2.1 Regular widget

As mentioned in the Low-power always-on sensing (LP-AoS) section, MSCLP enables scanning while the device is in Deep Sleep mode. This can reduce the power consumption while the device is in Active mode.

---

\(^1\) Refer to the CPU power modes section for more details on different PSoC™ 4 MCU power modes and resource availabilities.

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Firmware design considerations

**Code Listing 1** shows how to scan all the regular widgets while the device is in Deep Sleep mode.

```c
Cy_CapSense_ScanAllSlots(&cy_capsense_context);
while (Cy_CapSense_IsBusy(&cy_capsense_context)) {
    Cy_SysPm_CpuEnterDeepSleep ();
}
```

### 3.2.2 Low-power widget

MSCLP has a new widget called “Low-Power Widget” to scan sensors in wake-on-touch (WoT) mode. A low-power sensor that is required to be scanned while in low-power mode must be configured as the low-power widget (see **Figure 4**). These widgets are scanned and processed without any CPU intervention; they can act as a wakeup source for the device.

*Note:* For the normal operation of these buttons in active mode, these sensors need to be additionally configured as normal widgets such as button, proximity, slider, and touchpad. Buttons such as power-on/wakeup, ganged sensors, and proximity sensors are examples of a low-power widget.

![Figure 4: Add low-power widget](image-url)

**Figure 4** Add low-power widget
Achieving lowest-power capacitive sensing with PSoC™ 4000T

Firmware design considerations

To scan an LP widget in wake-on-touch (WoT) mode, there are new APIs added to CAPSENSE™ middleware; see Code Listing 2.

Code Listing 2

```c
Cy_CapSense_ScanAllLpSlots(&cy_capsense_context);
while (Cy_CapSense_IsBusy(&cy_capsense_context))
{
    Cy_SysPm_CpuEnterDeepSleep ();
}
```

The ScanAllLpSlots API scans all the configured low-power widgets based on Low-power widget parameters. See Section 3.4 for a complete low-power code example.

3.2.3 Refresh rate

As shown in Figure 2, there are many stages in different scan modes; the time spent in scanning has the maximum impact on power consumption. The amount of time for scanning sensors depends on the refresh rate and sensor frame scan time, as shown in Figure 5. As the refresh rate reduces, power consumption decreases but increases the response time. Therefore, the refresh rate should be decided based on the user requirement and power consumption.

For active mode, users expect to have an immediate response (maximum refresh rate). With a refresh rate of 128 Hz, the sensors are scanned every 7.8 ms; this can detect a touch in approximately 25 ms (considering debounce = 3 and no software filter; see AN85851 - PSoC™ 4 and PSoC™ 6 MCU CAPSENSE™ design guide for more details), which is in typical range of human response time. Therefore, any refresh rate above 128 Hz will provide a good user experience.

For low-power mode (WoT), the objective is to wake up the complete system on a touch event with the lowest power consumption possible. Any typical low-power solution tends to have a minimum of 0.5 sec long press to wake up the system. But MSCLP scanning at 16-Hz refresh rate can wake the system and report a touch event in less than 0.2 seconds (considering debounce = 1 and default hardware filter settings).
Firmware design considerations

![Diagram showing active, ALR, and WoT modes with their respective refresh rates and scan intervals.]

**Figure 5** Refresh rates in different power modes

### 3.2.3.1 MSCLP timer

The MSCLP CAPSENSE™ hardware contains a built-in low-power timer (MSCLP timer), which uses the internal ILO clock for timing. This timer can be used to control the refresh rate in different power modes. The MSCLP timer can be used in two ways based on application power modes.

In active and ALR modes, the MSCLP timer can act as a delay before starting a single-frame scan and used for controlling the refresh rate as shown in the following code snippet:

**Code Listing 3**

```c
for (; ;) {
    Cy_CapSense_ConfigureMsclpTimer (wakeupTimer, &cy_capsense_context);
    Cy_CapSense_ScanAllSlots(&cy_capsense_context);
    while (Cy_CapSense_IsBusy(&cy_capsense_context))
    {
        Cy_SysPm_CpuEnterDeepSleep ();
    }
    Cy_CapSense_ProcessAllWidgets(&cy_capsense_context);
}
```

The MSCLP block starts the scan of all slots (one frame) after the delay (wakeupTimer) set by the MSCLP timer configuration API.
Firmware design considerations

Therefore, refresh rate can be calculated using the following equation:

\[
\text{Refresh rate} = \frac{1}{\text{scan time} + \text{process time} + \text{wakeupTimer}}
\]

Equation 4  Refresh rate

3.2.4  Reducing the scan time in low-power mode

As mentioned in the previous section, the total scan time and refresh rate contribute to the power consumption. To reduce the total scan time, one way is to reduce the number of sensors, thereby reducing the Cp.

3.2.4.1  Wakeup/power-on button

Many low-power solutions are designed to have a wakeup or power-on button. Only this sensor needs to be scanned in low-power mode; a touch input to any other sensor is ignored. This type of design can have the maximum power saving, because the number of low-power buttons is limited to 1. In addition, the Cp of the total sensors to be scanned in low-power mode is the minimum; with a low Cp, the scan time is reduced and thereby reduces the power consumption.

3.2.4.2  Ganged sensors

Ganging multiple sensors help to reduce the power consumption if the requirement is to have the complete touch area as a wake-up source while in a low-power mode, for applications such as smart watches. To cover the complete touch area, all sensor electrodes should be scanned. Even though the total Cp that should be scanned for all the sensors is the same, it is beneficial to gang all sensors as one and perform a single scan because each individual sensor scan needs additional time for initialization, configuration, and processing.

3.2.4.3  Proximity sensors

Instead of ganged sensors, which require the full sensors to be scanned in low-power mode, proximity sensors can be used. Here, the device can wake up while the hand is approaching to the touch region; this can have a better user experience. As the approach of the hand itself wakes the system and the first touch will be considered for normal operation, the customer experience is identical to that of the device always being in active mode.

3.2.4.4  Touchpad-specific techniques

Solutions with touchpad which need the complete touchpad to be responding to touch while in deep sleep pose additional challenges because the total Cp of the complete touchpad is high.


A mutual capacitance (CSX) touchpad has several sensors compared to a self-capacitance (CSD) touchpad with the same dimensions and number of electrodes. For example, a 5 x 4 CSX touchpad (Figure 6) has 20 individual sensors to be scanned whereas in the CSD method, it is just 9 sensor scans. The number of sensors to be scanned in low-power mode can be further reduced by sensing only the row or column sensors as highlighted in Figure 7.
Firmware design considerations

By sensing the row or column sensors, the total Cp to be scanned in low-power mode can be further reduced. In addition, these sensors can be ganged to a single low-power widget to get the least power consumption.

2. **Configure outer electrodes as a proximity loop.**
A touchpad with a large number of electrodes will still have a high Cp to be scanned in low-power mode. In this case, configuring the outer electrodes as a single proximity sensor, reduces the total Cp scanned in low-power mode and provides the additional feature of waking up on proximity detection. Figure 8 shows the configuration of a proximity loop using outer electrodes in a 6x8 touchpad.
Firmware design considerations

![Diagram](image.png)

**Figure 8** 6 x 8 touchpad configured as a proximity loop

### 3.2.5 Shield design

For the CSD sensing method, a driven shield electrode can provide benefits such as liquid tolerance, and reduction in sensor Cp. Shield electrodes can be used in low-power design to reduce the power consumption because they decrease the sensor Cp.

A typical shield design consists of hatch patterns around the sensors in the top layer and directly beneath the sensors on bottom layers. For the low-power design, a driven shield can reduce the power consumption by reducing the sensor Cp but can increase the power consumption because the shield electrodes need to be additionally driven. In addition, a higher shield Cp can adversely affect power consumption as the maximum possible sense clock frequency will be limited by a large shield Cp. This increases the power consumption due to additional scan time requirement.

To avoid this, split the shield for Low-power and Active modes by configuring multiple pins as the shield, which is connected to independent shield regions. Design one of the shield regions specific to the low-power sensor (see Hardware design considerations). While in Low-power mode, configure this shield region/pin to be driven with the shield signal and connect the remaining shield to ground. This can reduce the sensor Cp, therefore reducing the overall power requirement in Low-power mode.

### 3.3 Low-power widget parameters

As mentioned in section 3.2.1, low-power widgets need to be used to design low-power designs, because they can provide advanced low-power features such as scan and process sensors while the CPU in Deep Sleep. This section explains different parameters specific to low-power widgets.

#### 3.3.1 Wake-on-touch scan interval

The scan interval is the time between two subsequent frame scans. The MSCLP CAPSENSE™ hardware contains a built-in low-power timer (MSCLP timer) which triggers the next frame scan while in WoT mode. This can be used to control the scan refresh rate while the device in WoT mode by appropriately providing the scan interval in milliseconds (see Figure 11). This timer uses the ILO clock; you can configure the scan interval in milliseconds for the required refresh rate.
Firmware design considerations

Note: If the frame scan time is bigger than the set scan interval, the next frame scan will start after the completion of the current frame.

3.3.2 Wake-on-touch timeout

While the device in WoT mode, the MSCLP hardware scans the low-power widget at set refresh rate and wakes up the device if there is a touch (see Figure 9) or if there is a timeout (see Figure 10). A timeout denotes the maximum number of frame scans while the device is in WoT mode before waking the device and moving to active mode.

![Figure 9 WoT wakeup due to touch detection](image1)

![Figure 10 WoT wakeup due to timeout](image2)

The timeout is required because the regular widget needs to be scanned and the baseline needs to be updated periodically to avoid drifting of the baseline because of environment variations such as temperature. The maximum timeout can be calculated using the following equation:
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Firmware design considerations

Equation 5  WoT timeout

\[
WoT \text{ Timeout} = WoT \text{ scan interval} \times \text{Number of frames in WoT}
\]

The internal 1-K SRAM of the MSCLP hardware acts as a FIFO to store the scan results (raw count). These stored raw counts are useful while tuning the low-power widgets or can also be used for any custom processing. The maximum number of raw counts which can be stored depends on the maximum internal memory size and number of low-power sensors; see Table 3.

Table 3  Maximum number of raw counts stored in MSCLP SRAM

<table>
<thead>
<tr>
<th>Number of low-power widgets</th>
<th>Maximum number of raw counts in SRAM</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>245</td>
</tr>
<tr>
<td>2</td>
<td>117</td>
</tr>
<tr>
<td>3</td>
<td>74</td>
</tr>
<tr>
<td>4</td>
<td>53</td>
</tr>
<tr>
<td>5</td>
<td>40</td>
</tr>
<tr>
<td>6</td>
<td>31</td>
</tr>
<tr>
<td>7</td>
<td>25</td>
</tr>
<tr>
<td>8</td>
<td>21</td>
</tr>
</tbody>
</table>

If the Number of frames in WoT is greater than the maximum number of raw counts which can be stored in the SRAM, the oldest raw counts will be replaced with the latest raw counts similar to how a FIFO works. The CAPSENSE™ tuner is capable of calculating the baseline using the MSCLP algorithm to recreate the baseline while the device is scanning in deep sleep mode. This can only work correctly if the Number of frames in WoT is less than or equal to Maximum number of Rawcounts in SRAM. You should ensure this while tuning the low-power widgets.

3.3.3  Low-power IIR filter

To detect a touch in WoT mode, MSCLP contains a hardware engine which runs the baseline update and touch detection algorithm. This works similar to CAPSENSE™ middleware processing, which applies an IIR filter to the rawcount and baseline, do signal calculation, and touch detection.

An IIR filter acts as a low-pass filter applied to the raw count passing the low-frequency signal (finger touch responses) and blocking high-frequency noise signal. Therefore, SNR will be improved for a given scan configuration; in other words, the same SNR can be achieved with a lower scan time or lower power consumption. The raw count can be calculated using the following equation:

\[
\text{RawCount} = \frac{1}{2^{\text{irRCcoef}}} \text{RawCount}_{\text{New}} + (1 - \frac{1}{2^{\text{irRCcoef}}})\text{RawCount}_{\text{Previous}}
\]

Equation 6  IIR filter applied on raw count

Here,

\( \text{irRCcoef} \) – IIR filter raw count coefficient; valid range: 1 to 8. A lower coefficient means lower filtering; a higher coefficient means a higher response time.
Firmware design considerations

The baseline IIR filter uses two different coefficients \(iirBLcoef_{\text{fast}}\) and \(iirBLcoef_{\text{slow}}\) for low-power widgets, based on the signal level. When the raw count starts to increase, the baseline value is updated quickly to attempt to track the raw count using \(iirBLcoef_{\text{fast}}\). However, once the noise threshold is exceeded, the baseline is updated slowly (using \(iirBLcoef_{\text{slow}}\)) if the raw count is increasing because of a touch/signal event. The baseline can be calculated using the following equation:

\[
\text{Baseline} = \frac{1}{2^{iirBLcoef_{\text{fast}}}} \times \text{Raw Count}_{\text{New}} + (1 - \frac{1}{2^{iirBLcoef_{\text{fast}}}}) \times \text{Baseline}_{\text{Previous}}
\]

**Equation 7**  Iir filter applied on baseline

Here,

\(iirBLcoef_{\text{fast}}\) – IIR filter baseline coefficient for fast update; valid range: 4 to 8.

\(iirBLcoef_{\text{slow}}\) – IIR filter baseline coefficient for slow update; valid range: 4 to 8.

**Figure 11** highlights the low-power widget-specific parameters in CAPSENSE™ Configurator.

---

**3.4 CIC2 filter**

Multi-sense low-power (MSCLP) CAPSENSE™ has a built-in cascaded integrator-comb 2 (CIC2) digital filter which improves the effective resolution, and thereby the SNR, for a given scan period. CIC2 filter is a 2\(^{nd}\) order digital low-pass (decimation) filter used to filter delta-sigma converters. **Figure 12** shows the representation of a CIC2 filter made up of a cascade of two integrators and two comb filters.
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Firmware design considerations

CIC2 filter receives the output of the MSCLP analog front-end which is a delta-sigma convertor. This converter generates a bitstream of 1s and 0s representing its input and moves the quantization noise to high frequencies. This high-frequency noise is filtered out by a digital low-pass filter; the downsampler converts the input to a single digital word representing the measured signal. This combination of a low-pass filter (A0, A1) and a downsampler (D0, D1) is known as a decimator (CIC2 filter) as shown in Figure 12.

![CIC2 filter block diagram](image)

The raw count gets accumulated at the end of each valid sample.

A minimum of two valid CIC2 samples are required for proper CIC2 filtering. Considering this the decimation(down-sampling) rate can be calculated using the following equation:

\[
Decimation\ rate\ (N) = \frac{Sns\_Clk\_Div \times Nsub}{3}
\]

**Equation 8  Decimation rate**

Configure the CIC2 Shift parameter as "Auto" in CAPSENSE™ configurator. This automatically selects the appropriate hardware shift (hardware divider).

The max raw count, when CIC2 is enabled, can be calculated using the following equation:

\[
Decimation\ rate\ (N) = \frac{Sns\_Clk\_Div \times Nsub}{3}
\]

**Equation 9  Max raw count**
3.5 Low-power CAPSENSE™ example

The code example CE235111 - PSoC™ 4: MSCLP CAPSENSE™ low-power demonstrates how to configure and manually tune the low-power widgets. In this code example, a single CSD button is scanned as a regular widget (for active and ALR modes) and low-power widget for WoT mode. The firmware flowchart (Figure 13) shows different user power modes and mode transition based on user activity.
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Device configuration considerations

4 Device configuration considerations

Section Firmware techniques for low-power design discusses firmware techniques for the CAPSENSE™ component to reduce the power consumption. In a user application, it is important to have the PSoC™ device and other peripherals to be configured to reduce the power consumption.

4.1 CPU and system clocks

In some cases, running the CPU clock faster can reduce the average current consumption. Having a faster clock can reduce the processing time. As shown in Figure 2, the processing stage has the highest current consumption. Reducing the processing time reduces the overall current consumption.

For example, in PSoC™ 4000T, the typical current consumption is 3 mA when the CPU clock is at 24 MHz and 5.4 mA when CPU clock is at 48 MHz. At a 48-MHz clock, even though the instantaneous current while in active mode is higher by ~80%, the average current for the same refresh rate is reduced by 10% because the processing time is halved (see AN86233: PSoC™ 4 MCU low-power modes and power reduction techniques for a detailed explanation).

4.2 CPU power modes

PSoC™ 4000T has three different power modes - active, sleep, and deep sleep.

- **Active mode** - Normal operating power mode in which all peripherals are available and the CPU is active. For a low-power CAPSENSE™ application, the sensor configuration, trigger scanning, and raw data processing occur in this mode.

- **Sleep mode** – CPU does not run any instruction and it waits for an interrupt to occur; all peripherals remain active. For PSoC™ 4000T with CAPSENSE™, this mode is not preferred.

- **Deep Sleep mode** - High-frequency clocks and peripherals that require high-frequency clocks are disabled, except the MSCLP CAPSENSE™ block. For achieving the lowest current consumption in low-power design, the device should be kept in this Deep Sleep as long as possible.

The WoT mode of CAPSENSE™ enables low-power scanning while the device is in Deep Sleep mode; this is enabled by the internal system resources and MSCLP timer. MSCLP is capable of generating local system resources (such as high-frequency clock) internal to the MSCLP block for scanning low-power sensors. The MSCLP timer can act as a periodic interrupt to start a complete frame scan according to the requirement.

The system power management (SysPm) API provides functions to change power modes. The API can also register callback functions to execute a peripheral function before or after power mode transitions. See section Low-power CAPSENSE™ example for low-power code example, which shows callback function usage and see Peripheral driver library documents for more details.
Device configuration considerations

4.3 Power state of other peripherals

Each peripheral component configured in the device increases the current consumption; it is recommended to turn off or disable every component which are not in use.

The SysPm driver provides three functions for callback: registration, deregistration, and execution. These functions not only help in power optimization, but also in preventing an abnormal peripheral state after mode transition. Most peripheral drivers have predefined callbacks associated with each power mode. For more information on callback registration and implementation, see AN86233 - PSoC™ 4 MCU low-power modes and power reduction techniques.

4.4 Unused pin states

Configure all unused pins that are connected to shield with drive mode to Analog High-Z. The drive mode can be set in the ModusToolbox™ Device Configurator or by using the following API function:

**Code Listing 4**

```c
/* Set MyPin to Analog HI-Z for low-power. */
Cy_GPIO_SetDrivemode(MYPIN_0_PORT, MYPIN_0_NUM, CY_GPIO_DM_HIGHZ);
```
Device configuration considerations

4.5 Debug pin state

By default, the programming and debugging interface in PSoC™ 4 is active in all the power modes. This causes high power consumption because the SWD pins will be in STRONG drive mode. To achieve minimum power consumption, set “Debug mode = NONE” in the Device Configurator; see Figure 15. This reconfigures the SWD pins to the drive mode selected by the user (Analog High-Z) after a delay from the device reset.

Note: When the debug interface is disabled by setting SWD pins to Analog High-Z, a reset must occur to access the debug controller inside the PSoC™ device.

Figure 15 Disabling the debug mode
Achieving lowest-power capacitive sensing with PSoC™ 4000T

5 Application-specific considerations

This section explains the possible cases where it is difficult to achieve low power. The two main scenarios that are possible are as follows:

- **Liquid tolerance**: Size of shield electrode, scanning of guard sensors, and implementation of additional firmware logics.
- **Robustness to noise**: Design needed to avoid false trigger of sensors. Possible cases are applications with extra firmware logics, EMC design specifications, and logics like reference sensor scan are influencing this.

5.1 Liquid-tolerant applications

Figure 16 shows the different power modes and transition conditions for a typical liquid-tolerant application. When the firmware detects liquid over the sensors, the application moves to the **Liquid Active** mode. A special liquid detection algorithm is executed in the firmware using a certain set of sensors to detect liquid on the surface. While in **Active** mode, the liquid detection algorithm needs to be executed every time before processing the sensors, as the liquid on the sensor can cause false detection. Once the device is in **Liquid Active** mode, the liquid detection algorithm is executed periodically to check if the liquid is removed from the touch surface, and the device can be safely moved to **Active** mode. The code example CE234752 - PSoC™ 4: MSCLP robust low-power liquid-tolerant CAPSENSE™ demonstrates how to implement a low-power, liquid-tolerant, and robust capacitive sensing solution.

In wearable applications, exposure to liquid is common (exposure to rain, swimming, physical activities, and so on) and for a longer period of time. Therefore, the power consumption is very critical in **Liquid Active** mode. The following sections provide recommendation for reducing the power consumption in this mode.
Achieving lowest-power capacitive sensing with PSoC™ 4000T

Application-specific considerations

5.1.1 Reducing refresh rate in Liquid Active mode

Even though there are sensors reporting signals in Liquid Active mode, scanning the sensors at high refresh rate is not required. In this mode, all the touch reporting is disabled and the condition to bring back the device to Active mode is slow (removal or dry up of liquid). Therefore, using a lower refresh rate such as 16 or 32 Hz decreases the power consumption while the solution is in contact with liquid.

5.2 Gesture applications

For low-power gesture applications, the wake-up method is very important to achieve best power optimization results.

5.2.1 Using Touch button on WoT

This is a simple and efficient method to achieve best scanning time and power utilization.

- It is a two-stage approach: wake-up by touch and gesture detection.
- It does not allow direct gesture on WoT mode as it has to wait till wake-up by touch and then scan for gesture.

5.2.2 Using proximity on WoT

Use proximity sensors around the track/touch pad, which can detect the presence of hand in the Wake-on-touch mode to put the system in Active mode for gesture detection.

Implement a proximity sensor by ganging other sensors together as shown in Figure 8. This is accomplished by combining multiple sensor pads into one large sensor using the firmware.

However, the application must consider the following points if opting for this solution:

- Application can do gesture detection directly after wake-up, when the wake-up sequence is invisible to the user. This is the time to reach the trackpad after proximity wake-up.
- It depends on the state transition time from WoT to Active mode to get the system ready for scanning after proximity detection.
- Grouping more sensors increases the scanning time and power consumption. Therefore, it is preferred to go with minimum number of sensors. This can be achieved by configuring proximity sensing with specific region/sides of the tracked pad.
- It introduces high parasitic capacitance.

Refer to the following documents for more information on proximity sensing:

- Proximity sensing section in AN64846 - Getting started with CAPSENSE™
- Gesture Section in CAPSENSE™ in AN85951 - PSoC™ 4 and PSoC™ 6 MCU CAPSENSE™ design guide
5.3 Robustness to external noise

5.3.1 Implementation of software filters

The proper software filter selection helps reduce external noise; see the “Software filtering” section in the AN64846 - Getting started with CAPSENSE™ application note for more details. It is recommended to consider the increase in power consumption due to increased processing time while configuring software filters.

5.3.2 Implementation of firmware logics

Adding additional customized firmware logics increases the processing time. Also, scanning logics like the reference sensor scan may lead to longer scanning time. In both cases, achieving low power is challenging.

5.3.3 Low-power EMC considerations

See “ESD protection” and “Electromagnetic compatibility (EMC) considerations” sections in the AN64846 - Getting started with CAPSENSE™ application note for general guidelines.

Radiated Immunity (RI) and Radiated Emission(RE) are the major points that need to be considered.

5.3.3.1 Radiated Immunity

1. Multi-frequency scanning (MFS) can prevent false touch detection in the presence of external noise at a particular frequency. However, MFS increases scanning time by 3x and increases power consumption as well.
2. Floating pins and traces can receive external noise and impact CAPSENSE™ performance. When such traces and pins are not in use, configuring them as shield can improve immunity.
3. Using a shield can improve immunity as well as increase the signal but it reduces the maximum possible scan frequency due to an increase in shield capacitance; this increases scan time as well as power consumption.
4. Increasing external series resistance (see Figure 17) decreases noise from input.

   However, this will have the following impacts:
   a) Decreases sense frequency (1/10 RC) and increase scan time and power.
   b) Reduces the signal and SNR values.

   This is a trade-off between noise immunity and power that the design should account for.
5. Eliminating high-transient voltages entering the system with proper design with decoupling capacitors, ferrite bead, and TVS diodes will improve noise immunity.

Figure 17 RC filter
Achieving lowest-power capacitive sensing with PSoC™ 4000T

Application-specific considerations

5.3.3.2 Radiated emission (RE)

1. RE can be reduced by shielding adjacent sensors (see section 6.1).
   a) When inactive sensor connections are shielded, it covers a large area, emitting more and consuming more power.
   b) Instead of shielding all the sensors, shield only the adjacent ones.
2. Any design configuration that has a high scanning time leads to more emissions (see the “Radiated emissions” section in the AN64846 - Getting started with CAPSENSE™ application note).
3. To avoid the antenna effect of cables carrying a signal outside, use properly shielded cables and as few sensors traces as possible.

The sensors planned for low-power WoT operation can be configured in such a way to meet RI and RE considerations during the initial design phase itself.
Achieving lowest-power capacitive sensing with PSoC™ 4000T

6 Hardware design considerations

In a CAPSENSE™ application, capacitive sensors are formed by the traces and pads of a printed circuit board (PCB) or flex circuit. A good hardware design ensures that the design is robust and helps in achieving low average power consumption. Poorly designed CAPSENSE™ hardware can lead to increased power consumption that cannot be fully compensated by firmware algorithm or sensor tuning. See AN85851 - PSoC™ 4 and PSoC™ 6 MCU CAPSENSE™ design guide for hardware considerations such as sensor construction, overlay selection, and PCB layout guidelines in the “Design considerations” section.

The following sections explain additional hardware design considerations specific to PSoC™ 4000T device to achieve low average power.

6.1 Shield regions

While in low-power mode - WoT, the recommendation is to have the low-power widget sensors with the lowest Cp possible. This can be achieved by reducing number of sensors as mentioned in section 3.2.4. Even after reducing the number of sensor or sensor pad area, Cp can be further reduced by having an active shield. Shield is a technique used by CAPSENSE™ to enable liquid tolerance and to reduce sensor Cp, in which the shield electrode is driven by a signal that is equal to the sensor switching signal in phase and amplitude. Shield electrodes are hatch patterns surrounding the sensors. The hatch pattern around the sensor can be driven as a shield for further reduction of Cp, therefore decreasing the current consumption. However, a larger shield having higher shield capacitance (Csh) limits the maximum frequency and therefore increases the scan time and current consumption.

The solution here is to have different isolated shield regions connected to PSoC™ through different pins. One shield electrode region surrounding just the low-power widgets. In low-power mode, the pin connected to this shield electrode region will be driven, therefore reducing the shield electrode Cp and also reducing the low-power sensor Cp in low-power mode. The other shield electrode region covers all the remaining sensors to be scanned in active mode.

In Figure 18, Shield Electrode 0 is driven with the shield signal while in WoT mode and both the shield electrodes (Shield Electrode 0 and Shield Electrode 1) are driven with the shield signal in Active mode.

![Figure 18: Independent shield electrodes for low-power sensor](image-url)
References

Product page
[1] PSoC™ 4000T

Device datasheet

Application notes
A large collection of application notes is available to get your design up and running fast. The following is the list of CAPSENSE™-specific applications notes:

[3] AN85951 - PSoC™ 4 and PSoC™ 6 CAPSENSE™ MCU design guide
[4] AN79953 - Getting started with PSoC™ 4 MCU

Development kits
[5] PSoC™ 4000T CAPSENSE™ Evaluation Kit (CY8CKIT-040T)

Component datasheet / middleware documentation
[6] PSoC™ 4 capacitive sensing
[7] CAPSENSE™ middleware library

ModusToolbox™
ModusToolbox™ software suite is used for the development of CAPSENSE™ applications based on PSoC™ 4 and PSoC™ 6. You can download the ModusToolbox™ software here. The related documents are as follows:

[12] ModusToolbox™ quick start guide
[14] ModusToolbox™ CAPSENSE™ Tuner
[16] ModusToolbox™ tools package user guide
References

Design support

[17] Infineon Developer Community – Connect with the technical community and exchange information.

[18] Technical support – Submit your design for review by creating a support case. You need to register and log in at the website to be able to contact Technical support. It is recommended to use PDF prints for the schematic and Gerber files with layer information for the layout.
Achieving lowest-power capacitive sensing with PSoC™ 4000T

Revision history

<table>
<thead>
<tr>
<th>Document revision</th>
<th>Date</th>
<th>Description of changes</th>
</tr>
</thead>
<tbody>
<tr>
<td>**</td>
<td>2022-06-14</td>
<td>Initial release.</td>
</tr>
</tbody>
</table>
| *A                | 2023-02-24 | Updated Power budgeting in Section 2.1.  
Updated power mode content in Section 3.1.1:  
Updated scanning mode content in Section 3.1.2:  
Added section 3.2.1: Regular Widget  
Updated shield design in Section 3.2.5:  
Updated current measurements in Table 1.  
Added "CIC2 shift value" column in Table 4.  
Updated Figure 1, Figure 2, Figure 5, Figure 9, and Figure 10: Added ALR mode after Active mode.  
Updated Figure 11: updated with IMO clock of 46 MHz.  
Added section 5 - Application-specific considerations. |
| *B                | 2023-03-02 | Corrected typo in Section 2.3.1.                                                        |
| *C                | 2023-07-11 | Updated Equation-9 in section 3.4.  
Updated Table 4.  
Updated Figure 11: updated latest GUI.  
Added section Gesture applications 5.2: Gesture applications.  
Removed Section 5.1.2. |
| *D                | 2023-07-28 | Removed the “restricted” tag in the header.                                           |
| *E                | 2023-09-07 | Updated Section 3.4.  
Removed Number of CIC2 samples equation.  
Updated Decimation rate equation.  
Removed CIC2 look-up table.  
Updated all the URLs to vanity URLs. |
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